

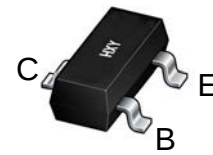


Feartures

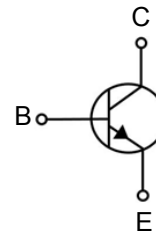
- Collector Current: $I_C=0.2A$
- Power Dissipation of 150mw

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
SMMBT3904TT1G	SOT-523	1N	3000



SOT-523



Maximum Ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V_{CBO}	60	V
Collector-Emitter Voltage	V_{CEO}	40	V
Emitter-Base Voltage	V_{EBO}	6	V
Collector Current	I_C	200	mA
Collector Power Dissipation	P_C	150	mW
Thermal Resistance From Junction To Ambient	$R_{\theta JA}$	833	°C/W
Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	-55~+150	°C

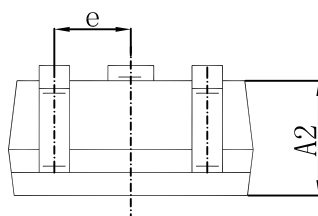
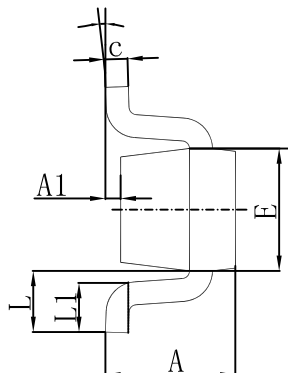
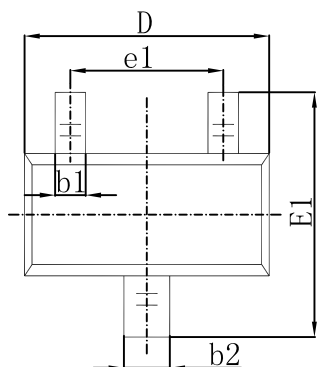


Electrcal Charcteristics (Ta=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=10\mu A, I_E=0$	60		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=1mA, I_B=0$	40		V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=10\mu A, I_C=0$	6		V
Collector cut-off current	I_{CEX}	$V_{CE}=30V, V_{EB(off)}=3V$		50	nA
Emitter cut-off current	I_{EBO}	$V_{EB}=5V, I_C=0$		100	nA
DC current gain	$h_{FE(1)}$	$V_{CE}=1V, I_C=0.1mA$	40		
	$h_{FE(2)}$	$V_{CE}=1V, I_C=1mA$	70		
	$h_{FE(3)}$	$V_{CE}=1V, I_C=10mA$	100	300	
	$h_{FE(4)}$	$V_{CE}=1V, I_C=50mA$	60		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=10mA, I_B=1mA$		0.2	V
		$I_C=50mA, I_B=5mA$		0.3	V
Collector-emitter saturation voltage	$V_{BE(sat)}$	$I_C=10mA, I_B=1mA$	0.65	0.85	V
		$I_C=50mA, I_B=5mA$		0.95	V
Transition frequency	f_T	$V_{CE}=20V, I_C=10mA, f=100MHz$	300		MHz
Collector output capacitance	C_{ob}	$V_{CB}=5V, I_E=0, f=1MHz$		4	pF
Base input capacitance	C_{ib}	$V_{EB}=0.5V, I_C=0, f=1MHz$		8	pF
Delay time	t_d	$V_{CC}=3V, V_{BE(off)}=-0.5V, I_C=10mA, I_{B1}=1mA$		35	ns
Rise time	t_r	$V_{CC}=3V, V_{BE(off)}=-0.5V, I_C=10mA, I_{B1}=1mA$		35	ns
Storage time	t_s	$V_{CC}=3V, I_C=10mA, I_{B1}=I_{B2}=1mA$		200	ns
Fall time	t_f	$V_{CC}=3V, I_C=10mA, I_{B1}=I_{B2}=1mA$		50	ns

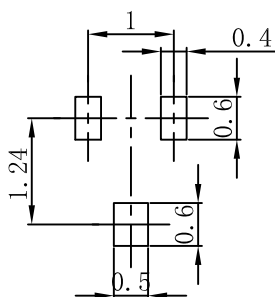


SOT-523 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

SOT-523 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$.
 3. The pad layout is for reference purposes only.



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